Probing potential to understand efficiency droop in InGaN LEDs

Korea University sees shift of electron depletion from light-emitting region to non-radiative p-type contact region with increasing current.

orea University has sought to better understand the efficiency droop phenomenon that hits the performance of indium gallium nitride (InGaN) light-emitting diodes (LEDs) at higher currents by using a conducting diamond tip to probe the potential in the various layers of the device [Taewoong Kim et al, Appl. Phys. Lett., vol108, p231101, 2016].

The sample for the voltage probing consisted of 2.5µm of n-GaN, a 110nm superlattice (SL), an 80nm multiple quantum well (MQW), a 45nm electron-blocking layer (EBL), 60nm of p-GaN, and 60nm of indium tin oxide (ITO). These layers were grown on sapphire. The

Maximum external quantum efficiency (EQE) was estimated to occur at 3.48A/cm², according to Jung et al.

The conductive diamond tip was designed for Seebeck microscopy. The conducting boron-doped diamond was grown by chemical vapor deposition (CVD). The tip radius was around 50nm. High contact pressure (~27GPa) was used to reduce the bandgap difference between the probe and sample, allowing electrical connection to be made. The contact diameter was around 25nm.

Measurements were carried out after about 10 minutes when the LED and probe had attained a thermal steady state. Potential profiles for four different



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from OV to negative value, approaching n-GaN.

measurements.

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current densities were averaged over 20 measurements to reduce noise effects (Figure 2).

The researchers interpret the kink in the profile as showing increased conductivity of electrons into the p-GaN region with increased current. These electrons then recombine non-radiatively in an electron 'depletion region'.

The researchers attribute the larger potential drop over the last part of the MQW region at higher currents (Figure 2d) as an indication that "more electrons and holes recombine in the last quantum well near the EBL as the current density increases."

Where efficiency droop begins to set in at lower current injection (Figure 2b), it is more difficult to see a kink and the researchers suggest that the electron depletion occurs then within the EBL.

At maximum EQE (Figure 2a), the researchers believe the electron depletion occurs in the MQW, as desired. "However, even the steepest voltage gradient in the profile shown in [Figure 2a] is relatively gentle compared with those shown in [Figures 2b-d]," the team writes. "This is because, at this lowest current density, the charge carriers deplete through a different mechanism (radiative recombination) to those occurring at other higher current densities (nonradiative recombination)."

The proportion of voltage drop across the MQW also varies with increasing current from \sim 50% of the total at 3.48A/cm² to \sim 30% at 22A/cm². "This directly shows that the proportion of the applied energy spent for radiative recombination decreases with increases in current density," the researchers comment.

The decrease in EQE in the same range is about 10%, compared with 40% ((50-30)/50) for the MQW potential drop fraction.

The researchers explain: "The actual electrochemical potential should be the average of the electrochemical potentials of electrons and holes weighted by carrier densities only. However, the measured voltage is the average of the electrochemical potentials weighted not only by the carrier densities but also by the carrier mobilities as well. As the mobility of electrons in GaN is much higher than that of holes, the measured voltage drop occurring in the EBL and p-GaN appears to be much greater than the actual potential energy drop."

The researchers give 50 as the approximate factor of electron/hole mobility in GaN. \blacksquare

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Figure 2. Averaged voltage profiles on cross section of operating LED obtained at (a) 3.48A/cm², (b) 10.02A/cm², (c) 15.38A/cm², and (d) 22.09A/cm².

